

### Typical Applications

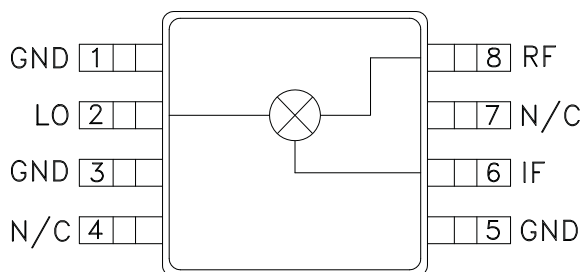
The HMC277MS8 / HMC277MS8E is ideal for:

- Cellular / 3G Infrastructure
- Basestations & Repeaters
- GSM, CDMA & WCDMA
- Subscribers & Portables

### Features

- Passive Topology
- LO / RF Isolation: 26 dB
- Input IP3: +21 dBm
- Low Conversion Loss: 9 dB
- RoHS Compliant MSOP-8 Package

### Functional Diagram



### General Description

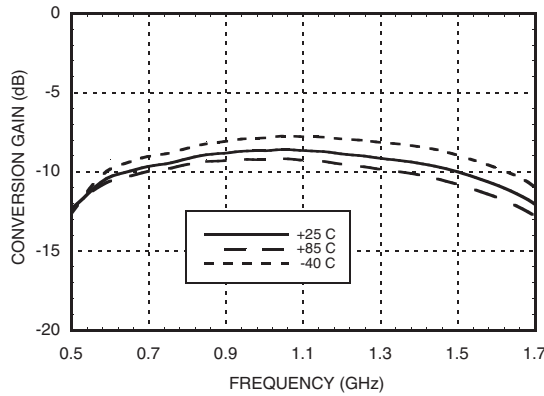
The HMC277MS8 & HMC277MS8E are general purpose single balanced mixers in 8 lead plastic surface mount Mini Small Outline Packages (MSOP). This passive MMIC mixer is constructed of GaAs Schottky diodes and a novel planar transformer balun on the chip. The HMC277MS8(E) requires no external matching components, and is ideal for upconverter and downconverter applications. The RF port is balanced via the MMIC balun while the LO port is connected directly to the diodes. This product is pin for pin compatible with the HMC272MS8(E) which operates from 1.7 to 3.0 GHz.

### Electrical Specifications, $T_A = +25^\circ \text{C}$ , LO = +13 dBm, IF = 100 MHz\*

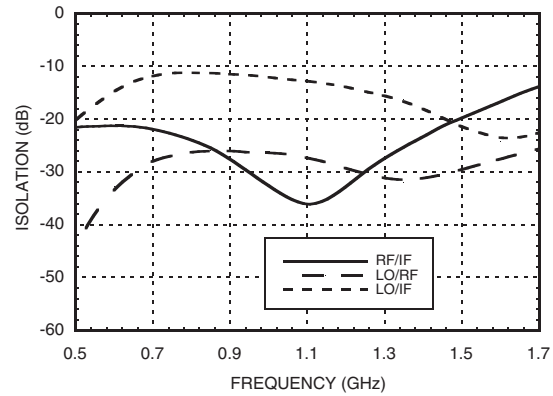
| Parameter                | Min.      | Typ. | Max. | Units |
|--------------------------|-----------|------|------|-------|
| Frequency Range, RF & LO | 0.7 - 1.2 |      |      | GHz   |
| Frequency Range, IF      | DC - 0.3  |      |      | GHz   |
| Conversion Loss          |           | 9    | 10.5 | dB    |
| Noise Figure (SSB)       |           | 9    | 10.5 | dB    |
| LO to RF Isolation       | 20        | 26   |      | dB    |
| LO to IF Isolation       | 8         | 12   |      | dB    |
| IP3 (Input)              | 17        | 21   |      | dBm   |
| 1 dB Compression (Input) | 9         | 12   |      | dBm   |

\*Unless otherwise noted, all measurements performed as a downconverter with low side LO.

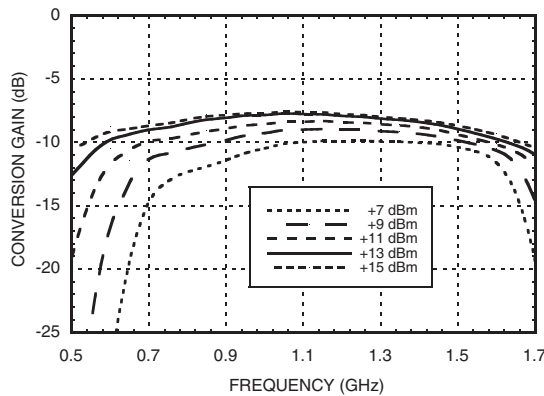
**Conversion Gain vs.  
Temperature @ LO = +13 dBm**



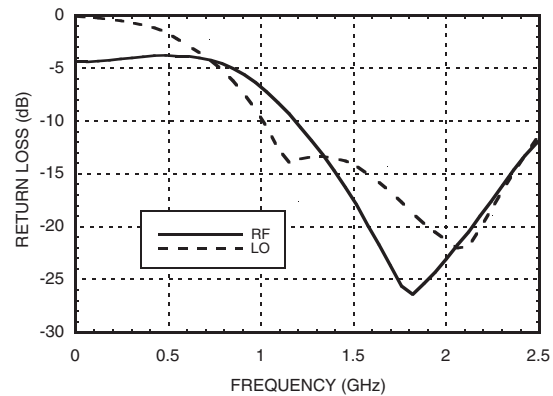
**Isolation @ LO = +13 dBm**



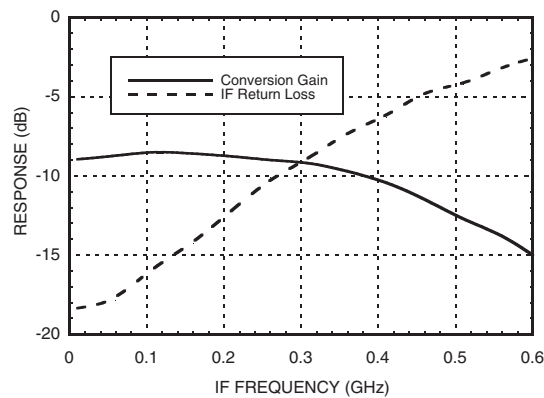
**Conversion Gain vs. LO Drive**



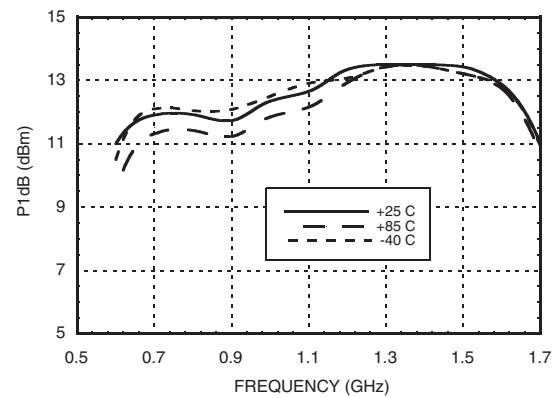
**Return Loss @ LO = +13 dBm**



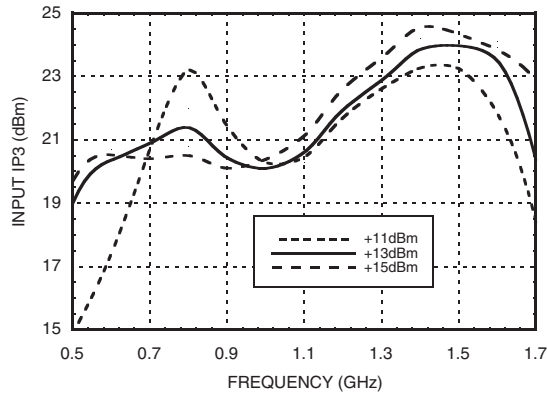
**IF Bandwidth &  
IF Return Loss @ LO = +13 dBm**



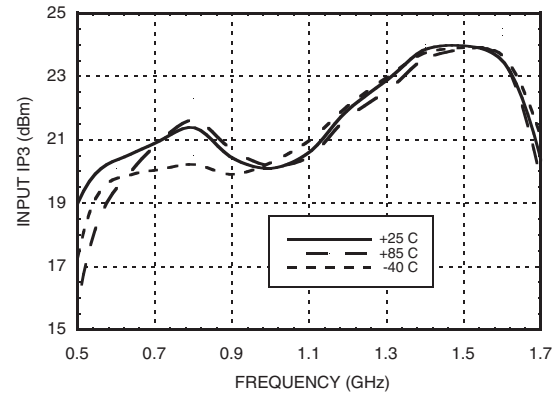
**P1dB vs. Temperature @ LO = +13 dBm**



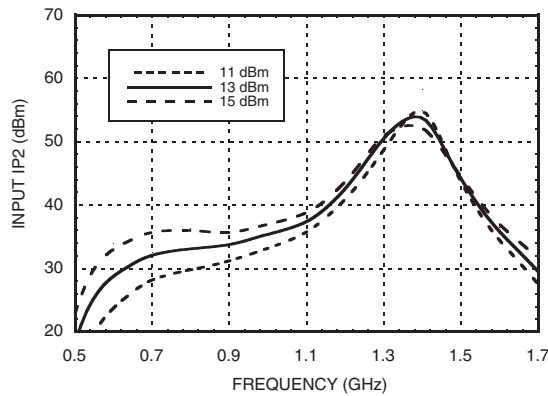
### Input IP3 vs. LO Drive



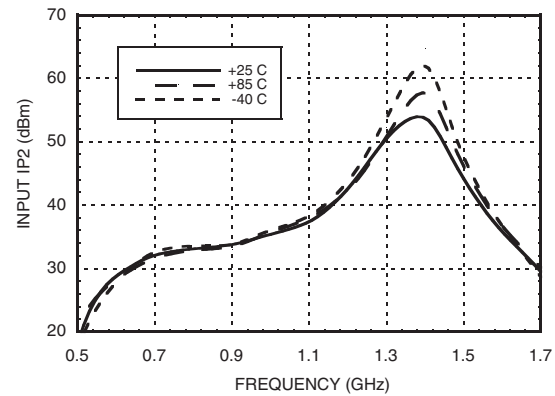
### Input IP3 vs. Temperature @ LO = +13 dBm



### Input IP2 vs. LO Drive



### Input IP2 vs. Temperature @ LO = +13 dBm



### MxN Spurious Outputs

|     | nLO |     |    |    |    |
|-----|-----|-----|----|----|----|
| mRF | 0   | 1   | 2  | 3  | 4  |
| 0   | xx  | -15 | 4  | 25 | 19 |
| 1   | 19  | 0   | 36 | 38 | 36 |
| 2   | 44  | 49  | 52 | 40 | 63 |
| 3   | 69  | 83  | 87 | 62 | 74 |
| 4   | 95  | 90  | 90 | 93 | 78 |

RF = 0.96 GHz @ -5 dBm  
LO = 0.8 GHz @ +13 dBm  
All values in dBc relative to the IF

### Harmonics of LO

|                    | nLO Spur at RF Port |    |    |    |
|--------------------|---------------------|----|----|----|
| LO Frequency (GHz) | 1                   | 2  | 3  | 4  |
| 0.5                | 31                  | 19 | 56 | 35 |
| 0.7                | 26                  | 14 | 46 | 40 |
| 0.9                | 26                  | 14 | 49 | 40 |
| 1.1                | 29                  | 20 | 48 | 39 |
| 1.3                | 31                  | 25 | 49 | 39 |
| 1.5                | 27                  | 29 | 58 | 42 |

LO = +13 dBm  
Values in dBc below input LO level measured at the RF port.

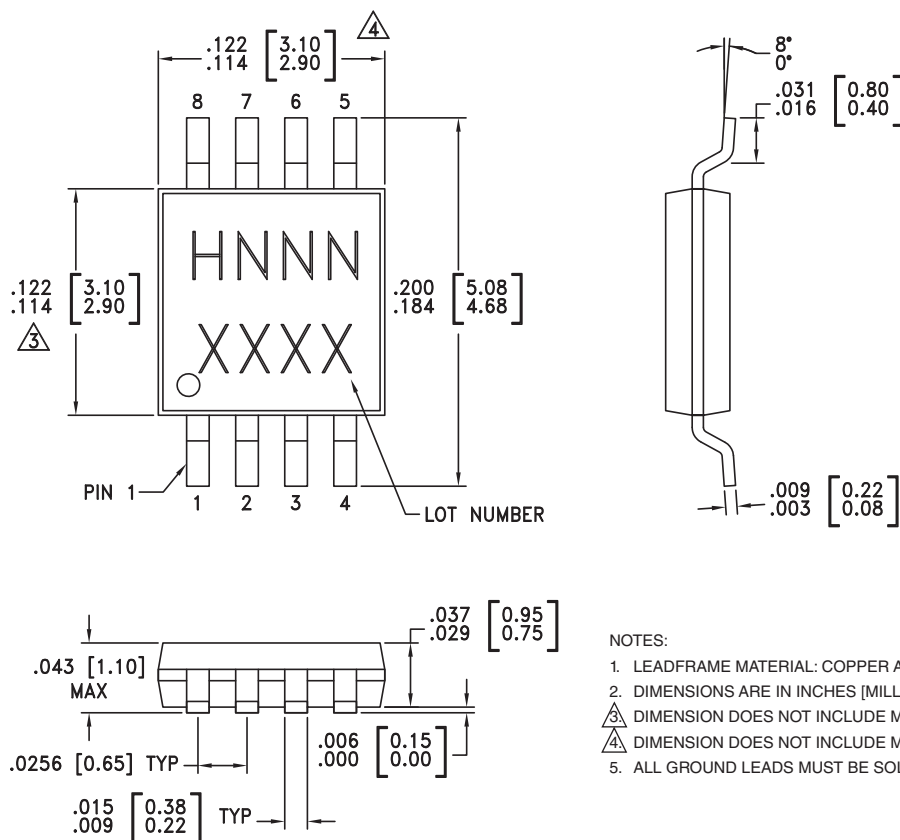
### Absolute Maximum Ratings

|                       |                |
|-----------------------|----------------|
| RF / IF Input         | +13 dBm        |
| LO Drive              | +27 dBm        |
| Storage Temperature   | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C  |
| ESD Sensitivity (HBM) | Class 1A       |



ELECTROSTATIC SENSITIVE DEVICE  
OBSERVE HANDLING PRECAUTIONS

### Outline Drawing



### Package Information

| Part Number | Package Body Material                              | Lead Finish   | MSL Rating          | Package Marking <sup>[3]</sup> |
|-------------|----------------------------------------------------|---------------|---------------------|--------------------------------|
| HMC277MS8   | Low Stress Injection Molded Plastic                | Sn/Pb Solder  | MSL1 <sup>[1]</sup> | H277<br>XXXX                   |
| HMC277MS8E  | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 <sup>[2]</sup> | H277<br>XXXX                   |

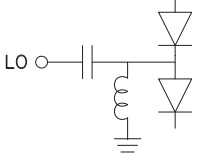
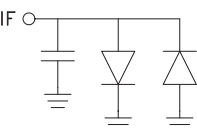
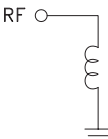
[1] Max peak reflow temperature of 235 °C

[2] Max peak reflow temperature of 260 °C

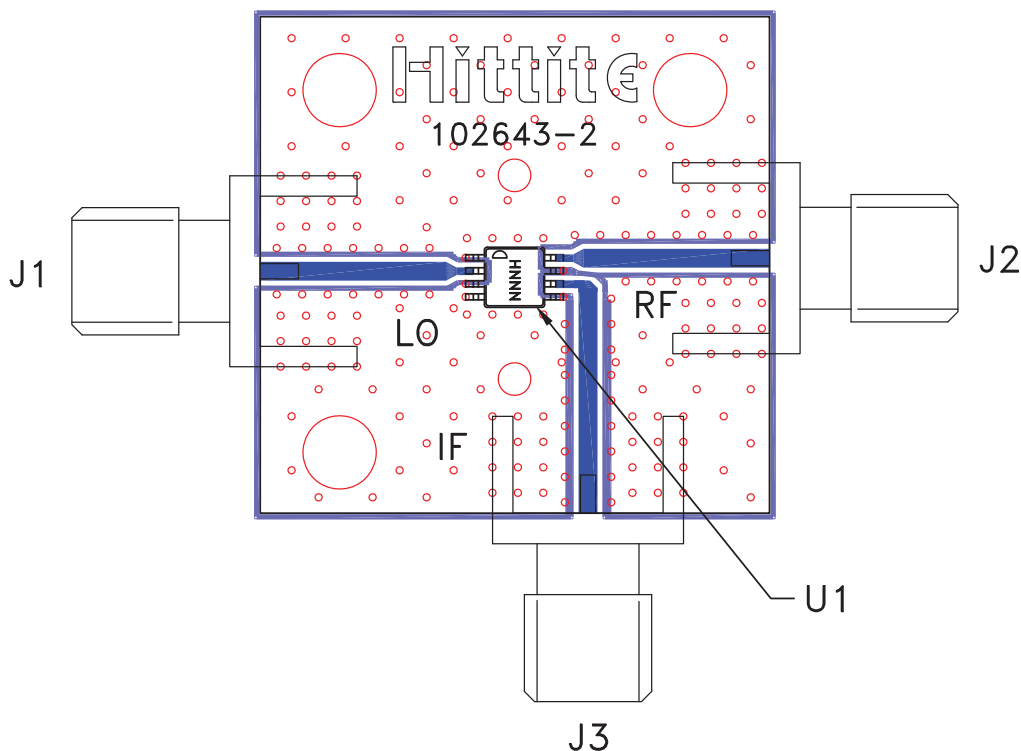
[3] 4-Digit lot number XXXX

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:  
20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373  
Order On-line at [www.hittite.com](http://www.hittite.com)

### Pin Descriptions

| Pin Number | Function | Description                                                                                                                                                                                                                                                                                             | Interface Schematic                                                                  |
|------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
| 1, 3, 5    | GND      | This pin must be connected to RF ground.                                                                                                                                                                                                                                                                |   |
| 2          | LO       | This pin is AC coupled and matched to 50 Ohms.                                                                                                                                                                                                                                                          |   |
| 4, 7       | N/C      | No connection required. These pins may be connected to RF/DC ground without affecting performance.                                                                                                                                                                                                      |                                                                                      |
| 6          | IF       | This pin is DC coupled. For applications not requiring operation to DC this port should be DC blocked externally using a series capacitor. Choose value of capacitor to pass IF frequency desired. For operation to DC, this pin must not sink/source more than 40 mA of current or failure may result. |   |
| 8          | RF       | This pin is DC coupled and matched to 50 Ohms.                                                                                                                                                                                                                                                          |  |

**Evaluation Circuit Board**



**List of Materials for Evaluation PCB 115791 [1]**

| Item    | Description                  |
|---------|------------------------------|
| J1 - J3 | PCB Mount SMA RF Connector   |
| U1      | HMC277MS8 / HMC272MS8E Mixer |
| PCB [2] | 102643 Evaluation Board      |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.